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103549842

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)/Execution Date(s):

Alfred Yeo
Kai Chong Chan

Execution Date(s) February 17, 2009, respectively

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other: _____

2. Name and address of receiving party(ies)

Name: Chartered Semiconductor Manufacturing, Ltd.

Internal Address: _____

Street Address: 60 Woodlands Industrial Park D

Street 2

City: _____

State: _____

Country: Singapore Zip: 738406

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Docket Clerk

Internal Address: P.O. Drawer 800889

Street Address: _____

City: Dallas

State: Texas Zip: 75380

Phone Number: (972) 628-3600

Fax Number: (972) 628-3616

Email Address: _____

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- ☐ Authorized to be charged by credit card
☐ Authorized to be charged to deposit account
☒ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers _____
Expiration Date _____

b. Deposit Account Number 50-0208

Authorized User Name _____

9. Signature:

Robert D. McCutcheon

Signature

February 17, 2009

Date

Robert D. McCutcheon, Reg. No. 38,717

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 4

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to:
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PATENT
REEL: 022319 FRAME: 0397

ASSIGNMENT

For good and valuable consideration, we, Alfred YEO, residing at Blk 351, #14-123, Ang Mo Kio Street 32, Singapore 560351, a citizen of Singapore and Kai Chong CHAN, residing at Blk 755, #15-56, Jurong West Street 74, Singapore 640755, a citizen of Singapore;

Hereby sell, assign, and transfer to **Chartered Semiconductor Manufacturing, Ltd.**, a corporation of Singapore, having its principal place of business at 60 Woodlands Industrial Park D Street 2, Singapore 738406,

hereinafter "Assignee," its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently here within, and is entitled:

**"CRACK STOP STRUCTURE ENHANCEMENT OF THE INTEGRATED
CIRCUIT SEAL RING"**

and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do

everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date:

17 / 02 / 2009

(Signature)

Alfred YEO

Witness 1:



(Signature)

NEA HONK WEL

(Print name)

Witness 2:

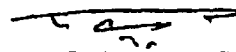


(Signature)

CHENG CHU FENG

(Print name)

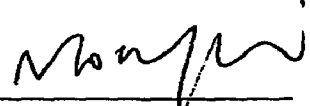
Date:

17 / 02 / 2009



(Signature)

Kai Chong CHAN

Witness 1:


(Signature)
NEO HONG WEI
(Print name)

Witness 2:


(Signature)
CHONG CHU KUO
(Print name)